



日本電子機械工業会規格  
Standard of Electronic Industries Association of Japan

**EIAJ ED-7311-12**

**集積回路パッケージ個別規格**  
**[52/64/80/100ピンロープロファイルクワッドフラット**  
**パッケージ (ヒートシンク露出タイプ)]**  
**Standard of integrated circuits package**  
**(52pins 64pins 80pins and 100pins**  
**Low-profile Quad Flat Package with Exposed Heatsink)**

1998年8月制定

作成  
半導体パッケージ標準化委員会  
Technical Standardization Committee on Semiconductor Device Package

発行  
社団法人 日本電子機械工業会  
Electronic Industries Association of Japan

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## 登録一覧表 REGISTRATION TABLE

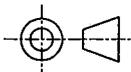
パッケージ名称: HLQFP

Package Name

登録番号: IC - 0000- xxx

Registration No.

		端子直線間隔 $e$ Terminal Pitch $e$	
		0.65	0.5
Nominal dimensions 呼び寸法 E × D	14 × 14	52 - 001 - AD	80 - 001 - AB
		64 - 001 - AC	100 - 001 - AA



EIAJ STANDARD  
PACKAGE OUTLINE DRAWINGS

DATE  
98-4-23

SHEET  
1 / 10

PACKAGE NAME  
HLQFP

EIAJ REGISTRATION NO.  
IC-0000-001